

**GaAs-IR-Lumineszenzdioden-Zeilen**  
**GaAs Infrared Emitter Arrays**  
**Lead (Pb) Free Product - RoHS Compliant**

**LD 260**

**LD 262 ... LD 269**



**Wesentliche Merkmale**

- GaAs-IR-Lumineszenzdioden
- Zeilenbauform, lieferbar von 2 bis 10 Emittoren pro Zeile
- Farbe: transparent
- Hohe Zuverlässigkeit
- Gruppiert lieferbar
- Gehäusegleich mit BPX 80-Serie
- Miniatur-Gehäuse

**Anwendungen**

- Miniaturlichtschranken für Gleich- und Wechsellichtbetrieb
- Barcodeleser
- Industrieelektronik
- „Messen/Steuern/Regeln“
- Sensorik
- Drehzahlsteuerung

**Features**

- GaAs infrared emitting diode
- Leadframe arrays, available from 2 to 10 Emitters per array
- Colour: transparent
- High reliability
- Available in bins
- Same package as BPX 80 series
- Miniature package

**Applications**

- Miniature photointerrupters
- Barcode readers
- Industrial electronics
- For control and drive circuits
- Sensor technology
- Speed controller

Typ Type	IRED pro Zeile per Row	Bestellnummer Ordering Code	Strahlstärkegruppierung <sup>1)</sup> ( $I_F = 50 \text{ mA}$ , $t_p = 20 \text{ ms}$ ) Radiant intensity grouping <sup>1)</sup> $I_e$ (mW/sr)
LD 262	2	Q62703Q0070	
LD 263	3	Q62703Q0071	
LD 264	4	Q62703Q0072	
LD 265	5	Q62703Q0073	
LD 266	6	Q62703Q0074	> 2.5 (typ. 5)
LD 267	7	Q62703Q0075	
LD 268	8	Q62703Q0076	
LD 269	9	Q62703Q0077	
LD 260	10	Q62703Q0078	

<sup>1)</sup> gemessen bei einem Raumwinkel  $\Omega = 0.01 \text{ sr}$  / measured at a solid angle of  $\Omega = 0.01 \text{ sr}$

**Grenzwerte ( $T_A = 25^\circ\text{C}$ )****Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Betriebs- und Lagertemperatur Operating and storage temperature range	$T_{op}; T_{stg}$	- 40 ... + 80	°C
Sperrsichttemperatur Junction temperature	$T_j$	80	°C
Sperrspannung Reverse voltage	$V_R$	5	V
Durchlassstrom Forward current	$I_F$	50	mA
Stoßstrom, $\tau \leq 10 \mu\text{s}, D = 0$ Surge current	$I_{FSM}$	1.6	A
Verlustleistung Power dissipation	$P_{tot}$	70	mW
Wärmewiderstand Thermal resistance	$R_{thJA}$ $R_{thJL}$	750 650	K/W K/W

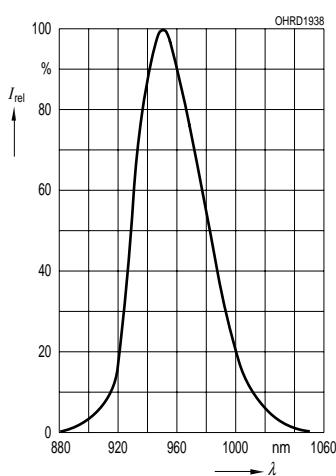
**Kennwerte ( $T_A = 25^\circ\text{C}$ )****Characteristics**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Wellenlänge der Strahlung Wavelength at peak emission $I_F = 50 \text{ mA}, t_p = 20 \text{ ms}$	$\lambda_{peak}$	950	nm
Spektrale Bandbreite bei 50% von $I_{max}$ Spectral bandwidth at 50% of $I_{max}$ $I_F = 50 \text{ mA}, t_p = 20 \text{ ms}$	$\Delta\lambda$	55	nm
Abstrahlwinkel Half angle	$\phi$	$\pm 15$	Grad deg.
Aktive Chipfläche Active chip area	$A$	0.25	$\text{mm}^2$
Abmessungen der aktiven Chipfläche Dimension of the active chip area	$L \times B$ $L \times W$	$0.5 \times 0.5$	$\text{mm}^2$
Abstand Chipoberfläche bis Linsenscheitel Distance chip surface to lens top	$H$	1.3 ... 1.9	mm

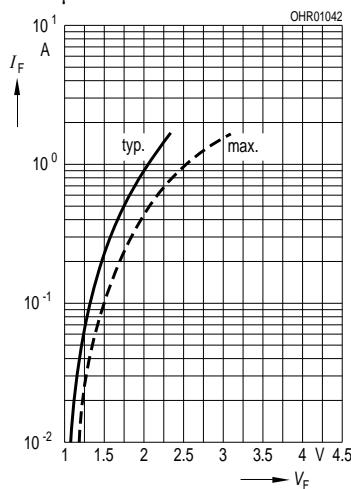
**Kennwerte ( $T_A = 25^\circ\text{C}$ )****Characteristics (cont'd)**

<b>Bezeichnung Parameter</b>	<b>Symbol Symbol</b>	<b>Wert Value</b>	<b>Einheit Unit</b>
Schaltzeiten, $I_e$ von 10% auf 90% und von 90% auf 10%, bei $I_F = 50 \text{ mA}$ , $R_L = 50 \Omega$ Switching times, $I_e$ from 10% to 90% and from 90% to 10%, $I_F = 50 \text{ mA}$ , $R_L = 50 \Omega$	$t_r, t_f$	1	$\mu\text{s}$
Kapazität, $V_R = 0 \text{ V}$ Capacitance	$C_o$	40	pF
Durchlassspannung, $I_F = 50 \text{ mA}$ , $t_p = 20 \mu\text{s}$ Forward voltage	$V_F$	1.25 ( $\leq 1.4$ )	V
Sperrstrom, $V_R = 5 \text{ V}$ Reverse current	$I_R$	0.01 ( $\leq 1$ )	$\mu\text{A}$
Gesamtstrahlungsfluss, $I_F = 50 \text{ mA}$ , $t_p = 20 \text{ ms}$ Total radiant flux	$\Phi_e$	9	mW
Temperaturkoeffizient von $I_e$ bzw. $\Phi_e$ , $I_F = 50 \text{ mA}$ Temperature coefficient of $I_e$ or $\Phi_e$ , $I_F = 50 \text{ mA}$	$TC_I$	- 0.55	%/K
Temperaturkoeffizient von $V_F$ , $I_F = 50 \text{ mA}$ Temperature coefficient of $V_F$ , $I_F = 50 \text{ mA}$	$TC_V$	- 1.5	mV/K
Temperaturkoeffizient von $\lambda_{\text{peak}}$ , $I_F = 50 \text{ mA}$ Temperature coefficient of $\lambda_{\text{peak}}$ , $I_F = 50 \text{ mA}$	$TC_\lambda$	0.3	nm/K
Strahlstärke, $I_F = 50 \text{ mA}$ , $t_p = 20 \text{ ms}$ Radiant intensity	$I_e$	typ. 5 ( $\geq 2$ )	mW/sr

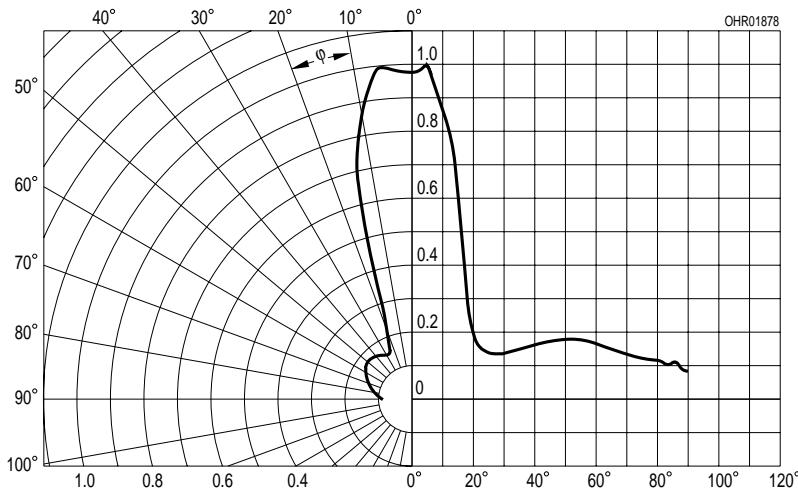
**Relative Spectral Emission**  
 $I_{\text{rel}} = f(\lambda)$



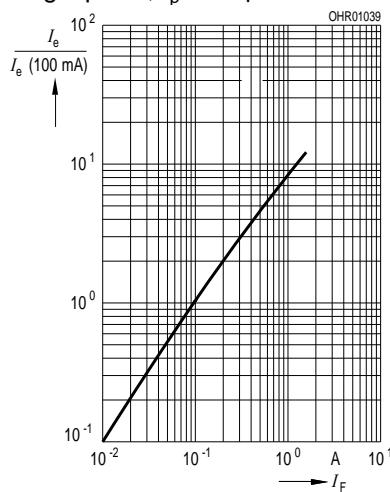
**Forward Current**  
 $I_F = f(V_E)$ , single pulse,  
 $t_p = 20 \mu\text{s}$



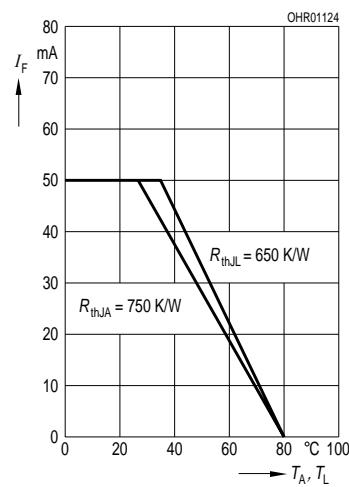
**Radiation Characteristics**  $I_{\text{rel}} = f(\phi)$



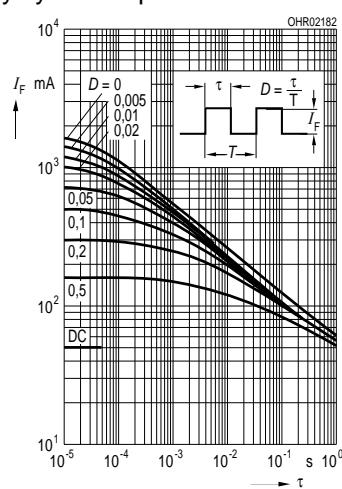
**Radiant Intensity**  $\frac{I_e}{I_e \text{ 100 mA}} = f(I_F)$   
Single pulse,  $t_p = 20 \mu\text{s}$

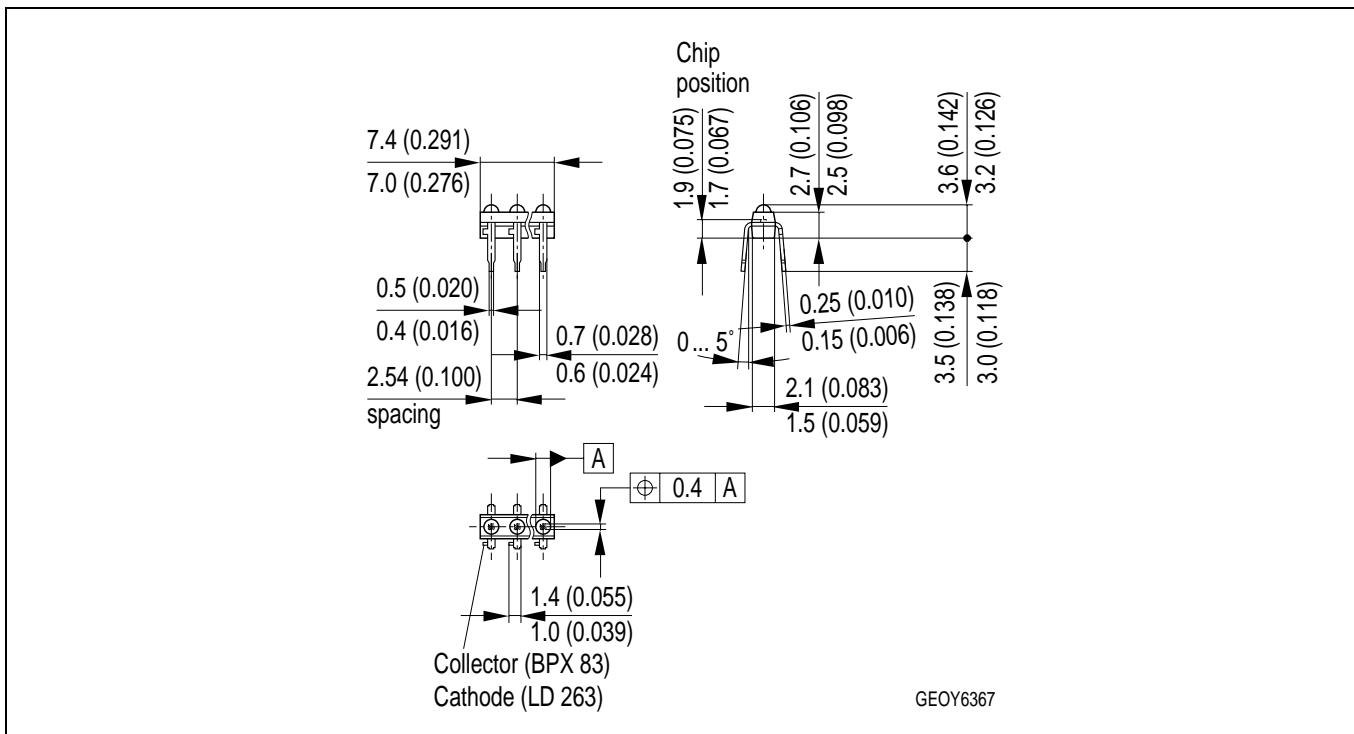


**Max. Permissible Forward Current**  
 $I_F = f(T_A)$



**Permissible Pulse Handling Capability**  $I_F = f(\tau)$ ,  $T_C = 25^\circ\text{C}$ ,  
duty cycle  $D = \text{parameter}$



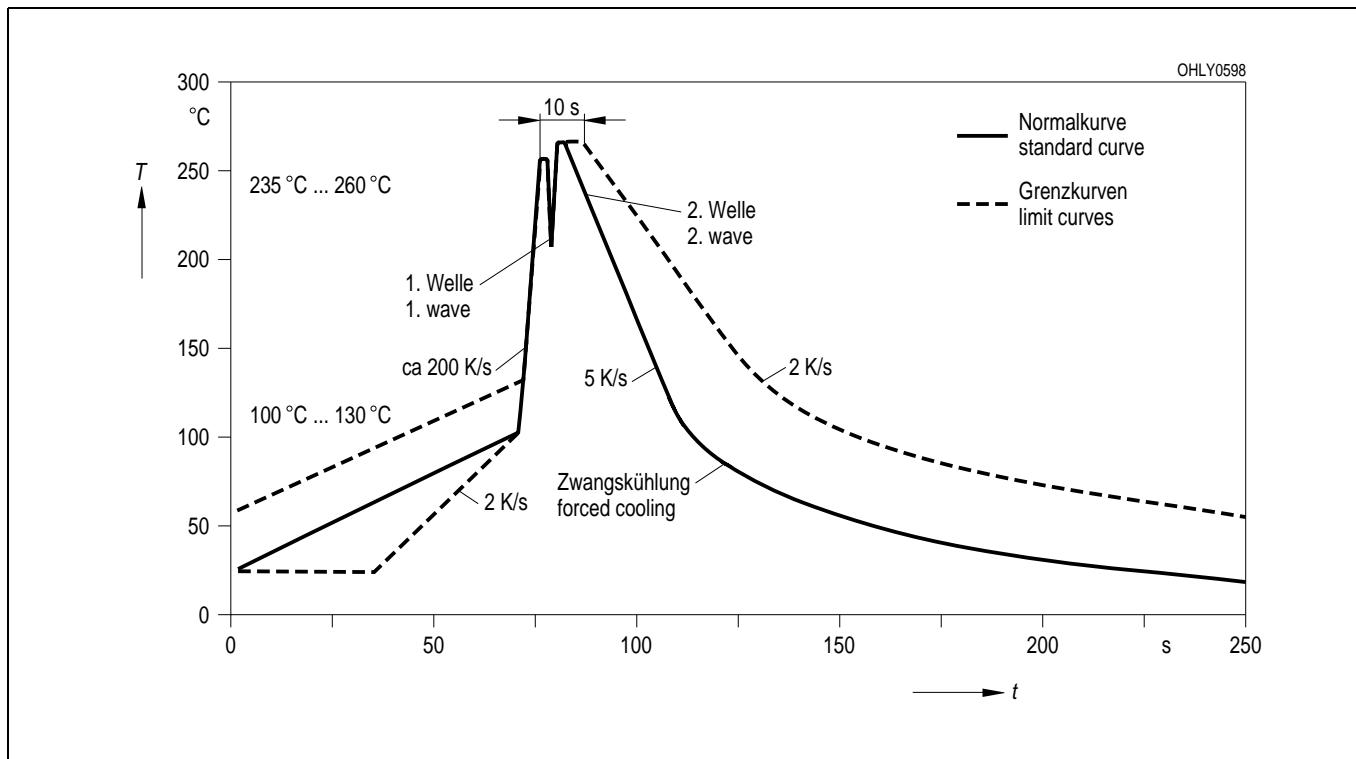
**Maßzeichnung  
Package Outlines**


Maße in mm (inch) / Dimensions in mm (inch).

Typ Type	IRED pro Zeile IRED per Row	Maß „A“ Dimension "A"
LD 262	2	4.5 ... 4.9
LD 263	3	7.0 ... 7.4
LD 264	4	9.6 ... 10.0
LD 265	5	12.1 ... 12.5
LD 266	6	14.6 ... 16.0
LD 267	7	17.2 ... 17.6
LD 268	8	19.7 ... 20.1
LD 269	9	22.3 ... 22.7
LD 270	10	24.8 ... 25.2

**Lötbedingungen**  
**Soldering Conditions**  
**Wellenlöten (TTW)**  
**TTW Soldering**

(nach CECC 00802)  
 (acc. to CECC 00802)



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